



REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PDR NO: T130409-3A	Dengfeng	2013.10.08
B	ECN NO: S140763	ANDY	2014.09.03
C	ECN NO: S160936-C	JIE-FU	2017.01.03

SPECIFICATIONS:

- INSULATION RESISTANCE BETWEEN ANY ADJACENT OPEN CIRCUIT TERMINAL SHELL NOT BE LESS THAN 100MΩ MEASURED BY 500 VDC.
- CONTACT RESISTANCE: 50mΩ MAX(INITIAL).
- INSULATION VOLTAGE WITHSTAND:500V AC FOR ONE MINUTE.
- UNLESS OTHERWISE SPECIFIED, TEST IS TO BE MADE AT 5-35°C IN TEMPERATURE AND 45-85% IN HUMIDITY. BUT,IF ANY VAGUE DATA IS OCCURED ON TEST RESULT, ANOTHER TEST SHALL BE MADE AT 20°C±2°C IN TEMP., 60-70% IN HUMIDITY.
- LIFE TEST: 10,000 CYCLES MIN.
- INSERTION FORCE: 0.3 - 3Kg.
- WITHDRAWAL FORCE: 0.3 - 3Kg.
- AFTER LIFE TEST, CONTACT RESISTANCE: 100mΩ MAX.
- AFTER HUMIDITY TEST, INSULATION RESISTANCE: 50MΩ MIN.
- MARKING: MARK "S" ON TOP OF CONNECTOR.
- PACKING : TAPE & REEL.
- TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT:
- HALOGEN FREE PRODUCT IDENTIFICATION LOGO ON PACKAGING:

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
G	DUMMY	1	SUS304-1/2H 0.25t	Ni 50u"
F	DET	1	SUS304-1/2H 0.25t	GOLD FLASH ON CONTACT AREA; GOLD FLASH ON SOLDER AREA; ALL OVER 50u" Ni.
E	L	1	PHOSPHOR BRONZE 0.2t	
D	RING	1	PHOSPHOR BRONZE 0.2t	
C	GROUND	1	PHOSPHOR BRONZE 0.2t	
B	MIC	1	PHOSPHOR BRONZE 0.2t	
A	BODY	1	HIGH TEMP.THERMOPLASTIC	BLACK

UNLESS OTHERWISE SPECIFIED TOLERANCES		Singatron Enterprise Co., Ltd. 信音企業股份有限公司	
DECIMALS:	ANGLES:	TITLE	3.5φ PHONE JACK
X :±0.5	X :±2°	DWN	JIE-FU PART NO. 2SJ3113-002111F
X.X :±0.3	X.X :±1°	CHKD	CERRY SCALE 4:1 UNIT: mm
X.XX :±0.2		APVD	LUSSEN SIZE: A3 SHEET:1 OF 1 REV:C
CUSTOMER COPY			